



Product Change Notification

Change Notification #: 114831 - 01

Change Title: Intel® Compute Stick STK2m3W64CC, Intel® Compute Stick STK2m364CC, Intel® Compute Stick STK2mv64CC, PCN 114831-01, Product Design, Label, Transport Media, BIOS Update, Chassis Modification, Label Update, Bag Change, and for SKU MM#944712 OS Image Update, **Reason for Revision: Change to BIOS version and Ready to Receive date modification.**

Date of Publication: September 06, 2016

Key Characteristics of the Change:

Product Design, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Sep 26, 2016
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Description of Change to the Customer:

Reason for Revision: Change to BIOS version and Ready to Receive date modification.

1. The BIOS will be updated. See table below for SKU and BIOS versions. To access the release notes or get a copy of the BIOS for evaluation, go to <http://downloadcenter.intel.com>.

Product Code	Previous BIOS	New BIOS
BLKSTK2M364CC	CCSKLM30.86A.0034	CCSKLM30.86A.0043
BOXSTK2M3W64CC	CCSKLM30.86A.0034	CCSKLM30.86A.0043
BLKSTK2MV64CC	CCSKLM5V.86A.0034	CCSKLM5V.86A.0043

2. For STK2m3W64CC the Operating System image will be updated to Windows 10* Home 64-bit RS1 version 1607.
3. The bottom cover SD card slot will be enlarged to prevent the potential of an SD card becoming stuck
4. The rating label bar code will be adjusted to 27mm for scanning improvement.

- The plastic bag will be changed to a new version to comply with Korean requirements for recycling. Korean recycling logo example below.



Customer Impact of Change and Recommended Action:

It is recommended that customers evaluate this new BIOS to ensure a smooth transition. This change has been thoroughly evaluated to ensure that there are no quality or reliability implications to our customers. Intel validation of a new board revision does not include testing with older versions of BIOS.

The changes to label, cover, and bag do not affect the functionality of the product. Customers should be aware of these changes.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

* Other names and brands may be claimed as the property of others.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
BOXSTK2M3W64CC	944712	H87908-206	H89289-502	H87908-207	H89289-503
BLKSTK2MV64CC	944715	H87914-205	H89290-502	H87914-206	H89290-503
BLKSTK2M364CC	944721	H87911-205	H89291-502	H87911-206	H89291-503

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
August 22, 2016	00	Originally Published PCN
September 6, 2016	01	Change to BIOS version and Ready to Receive date modification.



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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